

Electronic Patent Application Fee Transmittal

Application Number:	10678855			
Filing Date:	03-Oct-2003			
Title of Invention:	DICING/DIE-BONDING FILM, METHOD OF FIXING CHIPPED WORK AND SEMICONDUCTOR DEVICE			
First Named Inventor/Applicant Name:	Takeshi Matsumura			
Filer:	Kerry S. Taylor/Chiaki Kokka			
Attorney Docket Number:	UNIU79.014AUS			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Certificate of correction	1811	1	100	100
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				100